

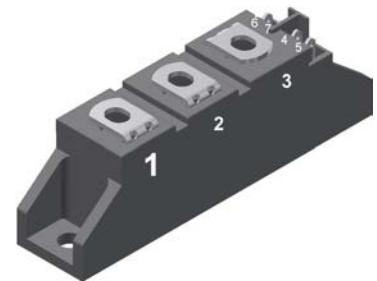
# Thyristor Module

$V_{RRM}$  = 2x 1400 V  
 $I_{TAV}$  = 27 A  
 $V_T$  = 1,27 V

## Phase leg

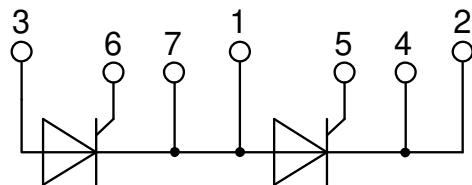
### Part number

**MCC26-14io1**



Backside: isolated

 E72873



### Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al2O3-ceramic

### Applications:

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

### Package: TO-240AA

- Isolation Voltage: 4800 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

### Disclaimer Notice

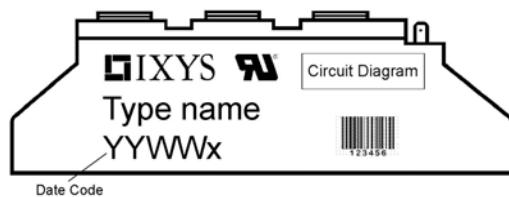
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**Thyristor**

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$V_{RSM/DSM}$	max. non-repetitive reverse/forward blocking voltage	$T_{VJ} = 25^\circ\text{C}$			1500	V
$V_{RRM/DRM}$	max. repetitive reverse/forward blocking voltage	$T_{VJ} = 25^\circ\text{C}$			1400	V
$I_{R/D}$	reverse current, drain current	$V_{R/D} = 1400 \text{ V}$ $V_{R/D} = 1400 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		100 3	$\mu\text{A}$ mA
$V_T$	forward voltage drop	$I_T = 40 \text{ A}$	$T_{VJ} = 25^\circ\text{C}$		1,27	V
		$I_T = 80 \text{ A}$			1,64	V
		$I_T = 40 \text{ A}$	$T_{VJ} = 125^\circ\text{C}$		1,27	V
		$I_T = 80 \text{ A}$			1,65	V
$I_{TAV}$	average forward current	$T_C = 85^\circ\text{C}$	$T_{VJ} = 125^\circ\text{C}$		27	A
$I_{T(RMS)}$	RMS forward current	180° sine			42	A
$V_{TO}$	threshold voltage	$r_T$ slope resistance } for power loss calculation only	$T_{VJ} = 125^\circ\text{C}$		0,85	V
	slope resistance				11	$\text{m}\Omega$
$R_{thJC}$	thermal resistance junction to case				0,88	K/W
$R_{thCH}$	thermal resistance case to heatsink			0,2		K/W
$P_{tot}$	total power dissipation		$T_C = 25^\circ\text{C}$		115	W
$I_{TSM}$	max. forward surge current	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$	$T_{VJ} = 45^\circ\text{C}$		520	A
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$	$V_R = 0 \text{ V}$		560	A
		$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$	$T_{VJ} = 125^\circ\text{C}$		440	A
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$	$V_R = 0 \text{ V}$		475	A
$I^2t$	value for fusing	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$	$T_{VJ} = 45^\circ\text{C}$		1,35	$\text{kA}^2\text{s}$
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$	$V_R = 0 \text{ V}$		1,31	$\text{kA}^2\text{s}$
		$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$	$T_{VJ} = 125^\circ\text{C}$		970	$\text{A}^2\text{s}$
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$	$V_R = 0 \text{ V}$		940	$\text{A}^2\text{s}$
$C_J$	junction capacitance	$V_R = 400 \text{ V}$ $f = 1 \text{ MHz}$	$T_{VJ} = 25^\circ\text{C}$	22		pF
$P_{GM}$	max. gate power dissipation	$t_p = 30 \mu\text{s}$	$T_C = 125^\circ\text{C}$		10	W
		$t_p = 300 \mu\text{s}$			5	W
$P_{GAV}$	average gate power dissipation				0,5	W
$(di/dt)_{cr}$	critical rate of rise of current	$T_{VJ} = 125^\circ\text{C}; f = 50 \text{ Hz}$ repetitive, $I_T = 45 \text{ A}$			150	$\text{A}/\mu\text{s}$
		$t_p = 200 \mu\text{s}; di_G/dt = 0,45 \text{ A}/\mu\text{s};$				
		$I_G = 0,45 \text{ A}; V_D = \frac{2}{3} V_{DRM}$ non-repet., $I_T = 27 \text{ A}$			500	$\text{A}/\mu\text{s}$
$(dv/dt)_{cr}$	critical rate of rise of voltage	$V_D = \frac{2}{3} V_{DRM}$	$T_{VJ} = 125^\circ\text{C}$		1000	$\text{V}/\mu\text{s}$
		$R_{GK} = \infty$ ; method 1 (linear voltage rise)				
$V_{GT}$	gate trigger voltage	$V_D = 6 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$		1,5	V
			$T_{VJ} = -40^\circ\text{C}$		1,6	V
$I_{GT}$	gate trigger current	$V_D = 6 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$		100	mA
			$T_{VJ} = -40^\circ\text{C}$		200	mA
$V_{GD}$	gate non-trigger voltage	$V_D = \frac{2}{3} V_{DRM}$	$T_{VJ} = 125^\circ\text{C}$		0,2	V
$I_{GD}$	gate non-trigger current				10	mA
$I_L$	latching current	$t_p = 10 \mu\text{s}$ $I_G = 0,45 \text{ A}; di_G/dt = 0,45 \text{ A}/\mu\text{s}$	$T_{VJ} = 25^\circ\text{C}$		450	mA
$I_H$	holding current	$V_D = 6 \text{ V}$ $R_{GK} = \infty$	$T_{VJ} = 25^\circ\text{C}$		200	mA
$t_{gd}$	gate controlled delay time	$V_D = \frac{1}{2} V_{DRM}$	$T_{VJ} = 25^\circ\text{C}$		2	$\mu\text{s}$
		$I_G = 0,45 \text{ A}; di_G/dt = 0,45 \text{ A}/\mu\text{s}$				
$t_q$	turn-off time	$V_R = 100 \text{ V}; I_T = 20 \text{ A}; V_D = \frac{2}{3} V_{DRM}$ $T_{VJ} = 100^\circ\text{C}$ $di/dt = 10 \text{ A}/\mu\text{s}; dv/dt = 20 \text{ V}/\mu\text{s}; t_p = 200 \mu\text{s}$		150		$\mu\text{s}$

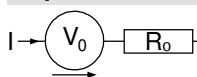
**Package TO-240AA**

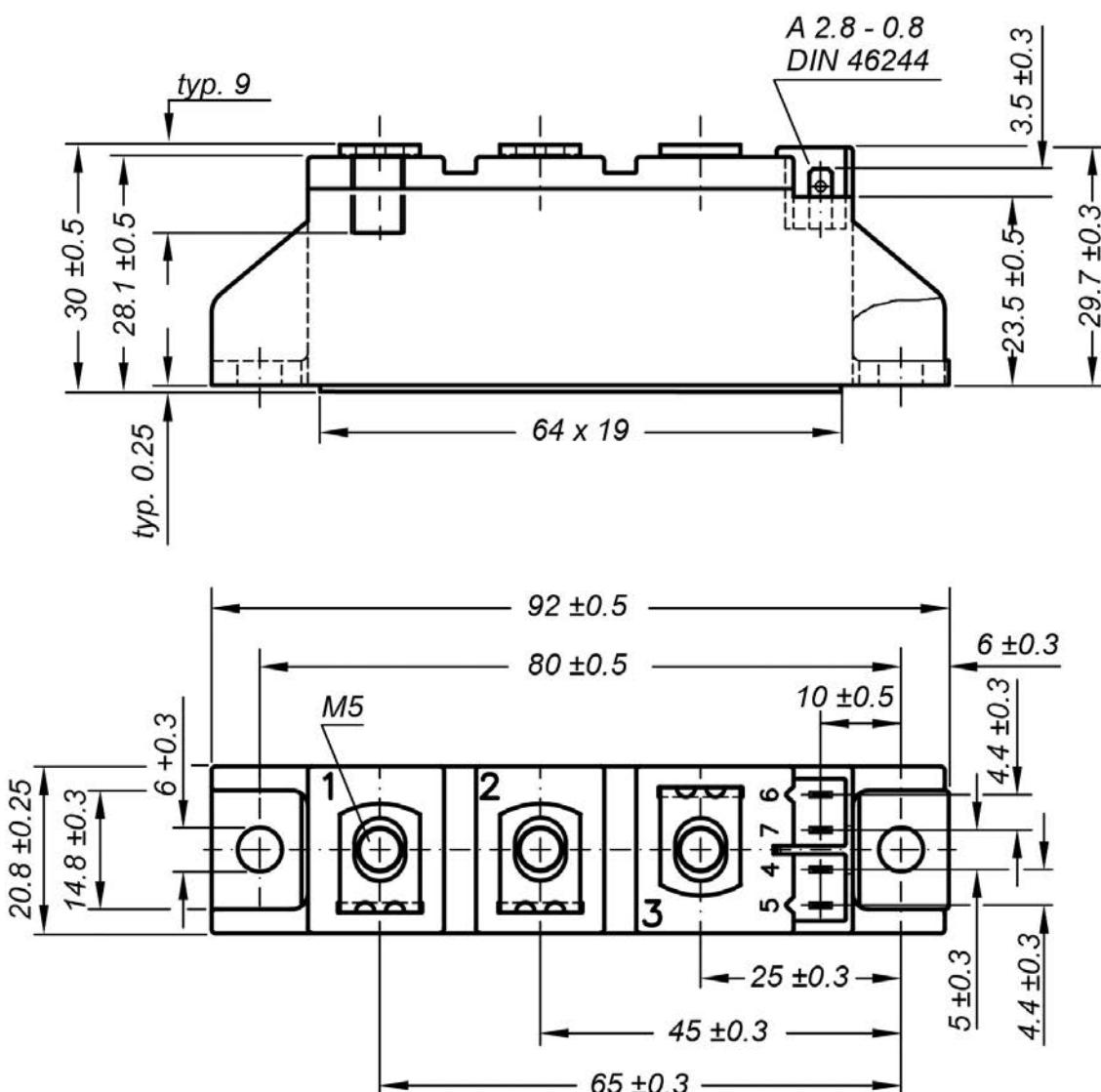
Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$I_{RMS}$	RMS current	per terminal			200	A
$T_{VJ}$	virtual junction temperature		-40		125	°C
$T_{op}$	operation temperature		-40		100	°C
$T_{stg}$	storage temperature		-40		125	°C
<b>Weight</b>				81		g
$M_D$	mounting torque		2,5		4	Nm
$M_T$	terminal torque		2,5		4	Nm
$d_{Spp/App}$	creepage distance on surface   striking distance through air	terminal to terminal	13,0	9,7		mm
$d_{Spb/Apb}$		terminal to backside	16,0	16,0		mm
$V_{ISOL}$	isolation voltage	$t = 1$ second $t = 1$ minute	50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA		4800 4000	V V



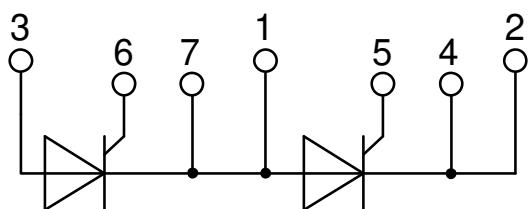
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCC26-14IO1	MCC26-14IO1	Box	36	442348

**Equivalent Circuits for Simulation**
\* on die level
 $T_{VJ} = 125^\circ\text{C}$ 

	<b>Thyristor</b>	
$V_{0\ max}$	threshold voltage	0,85 V
$R_{0\ max}$	slope resistance *	9,8 mΩ

**Outlines TO-240AA**

**Optional accessories for modules**

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red  
Type ZY 200L (L = Left for pin pair 4/5)  
Type ZY 200R (R = Right for pin pair 6/7) } UL 758, style 3751



## Thyristor

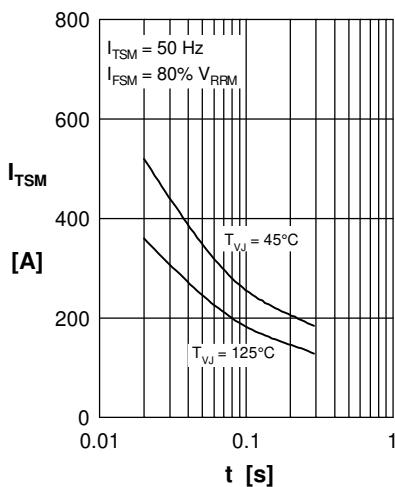


Fig. 1 Surge overload current  $I_{TSM}$ ,  
 $I_{FSM}$ : Crest value, t: duration

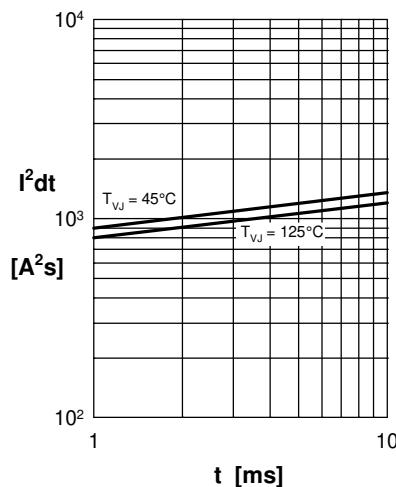


Fig. 2  $I^2t$  versus time (1-10 ms)

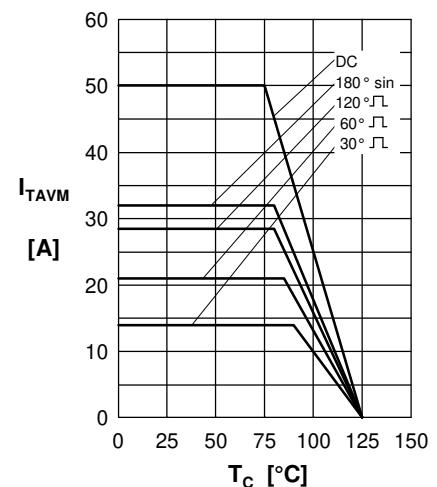


Fig. 3 Max. forward current  
at case temperature

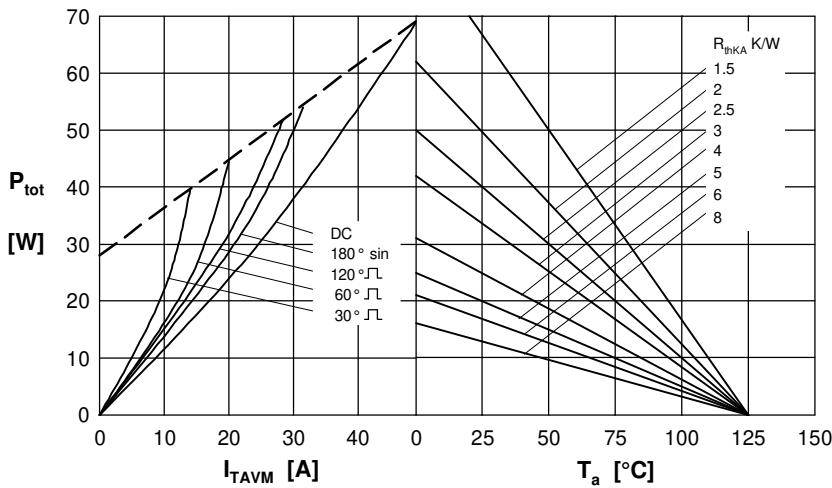


Fig. 4 Power dissipation vs. on-state current & ambient temperature  
(per thyristor or diode)

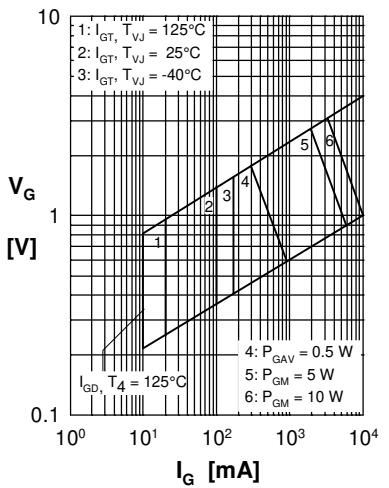


Fig. 5 Gate trigger characteristics

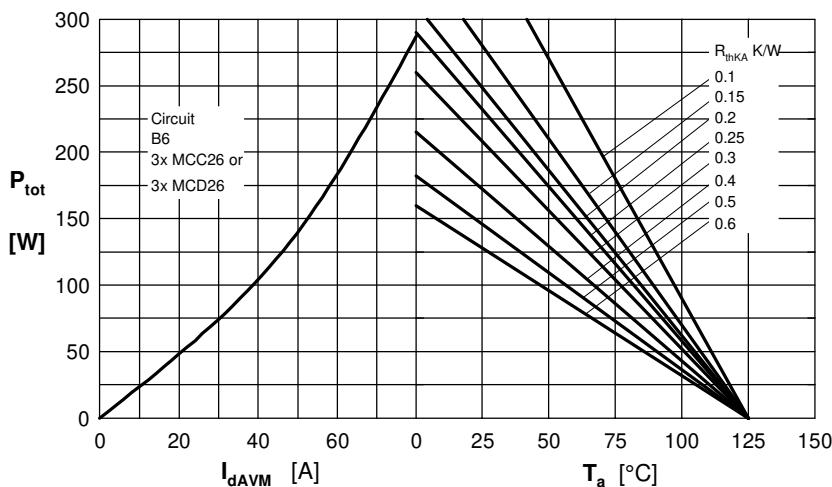


Fig. 6 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

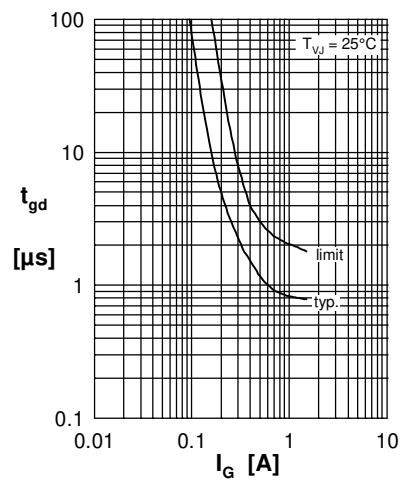


Fig. 7 Gate trigger delay time

## Thyristor

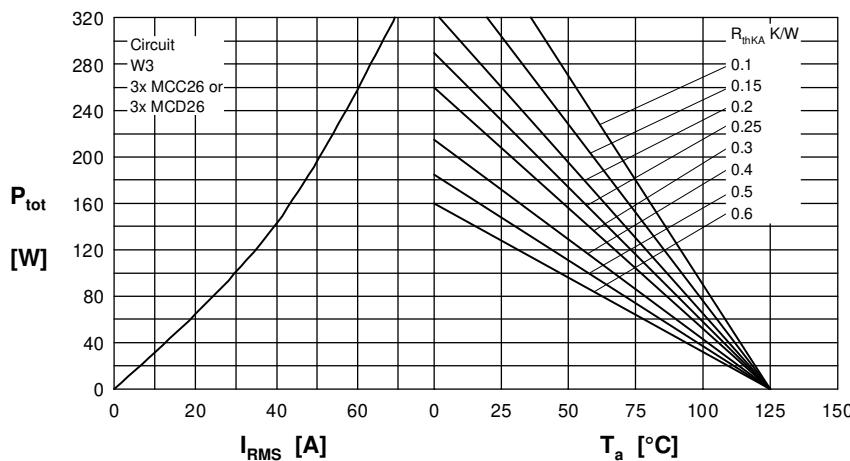


Fig. 8 Three phase AC-controller: Power dissipation versus RMS output current and ambient temperature

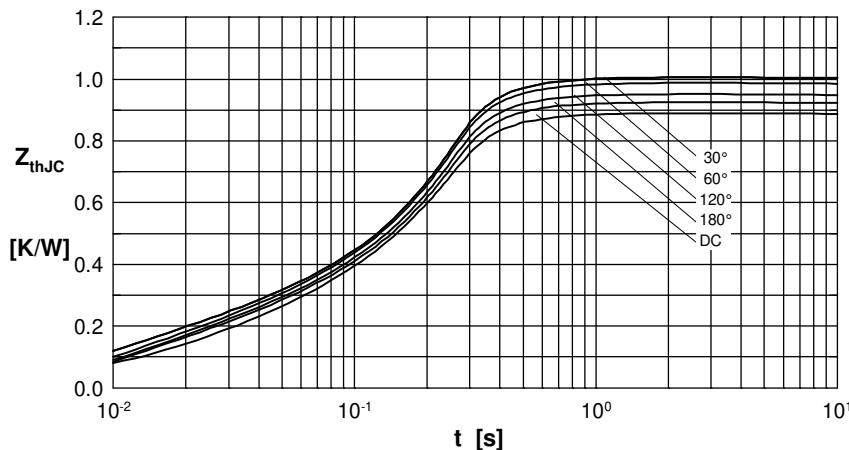


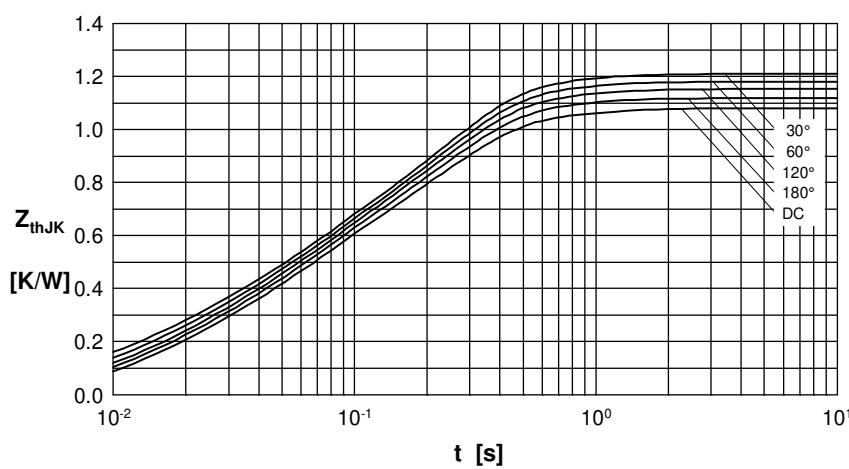
Fig. 9 Transient thermal impedance junction to case (per thyristor/diode)

$R_{thJC}$  for various conduction angles d:

d	$R_{thJC}$ [K/W]
DC	0.88
180°	0.92
120°	0.95
60°	0.98
30°	1.01

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ [K/W]	$t_i$ [s]
1	0.019	0.0031
2	0.029	0.0216
3	0.832	0.1910



$R_{thJK}$  for various conduction angles d:

d	$R_{thJK}$ [K/W]
DC	1.08
180°	1.12
120°	1.15
60°	1.18
30°	1.21

Constants for  $Z_{thJK}$  calculation:

i	$R_{thi}$ [K/W]	$t_i$ [s]
1	0.019	0.0031
2	0.029	0.0216
3	0.832	0.1910
4	0.200	0.4500

Fig. 10 Transient thermal impedance junction to heatsink (per thyristor/diode)